



IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re Application of:

Jiang et al.

Serial No.: 09/483,712

Filed: January 14, 2000

For: CHIP-SCALE PACKAGES HAVING
ENCAPSULATED CARRIER BONDS (as
amended)

Confirmation No.: 8743

Examiner: M. Warren

Group Art Unit: 2815

Attorney Docket No.: 2269-3815.1US
(98-0670)

CERTIFICATE OF MAILING

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RESPONSE TO FINAL OFFICE ACTION

Box AF
Commissioner for Patents
Washington, D.C. 20231

Sir:

The following remarks are filed in response to the Examiner's remarks in the Final Office Action mailed December 31, 2002, the three-month shortened statutory period for response to which expires on March 31, 2003. This response is submitted on or before two months from the mailing date of the Final Office Action.